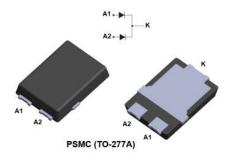


STPS660CSFY

Datasheet

Automotive 60 V, dual 3 A power Schottky rectifier



Features

- AEC-Q101 qualified
- PPAP capable
- 175 °C maximum operation junction temperature
- V_{RRM} guaranteed from -40 °C to 175 °C
- High surge current capability
- ECOPACK2 compliant component

Application

- Reverse polarity protection in E.C.U
- DC/DC converters
- Freewheeling diodes

Description

The STPS660CSFY has been developed for applications requiring an optimized VF and leakage current characteristics.

These characteristics make it ideal for use in secondary rectification functions, such as DC/DC converters or freewheeling functions.

Product status link				
STPS660CSFY				
Product summary				
Symbol Value				
I _{F(AV)}	2 X 3 A			
V _{RRM}	60 V			
T _j (max.)	175 °C			
V _F (typ.)	0.50 V			

1 Characteristics

(7/

Table 1. Absolute ratings (limiting values per diode at 25 °C, unless otherwise specified)

Symbol	Parameter			Value	Unit	
V _{RRM}	Repetitive peak reverse voltage (T _j = -40 °C to +175 °C)			60	V	
1	Average forward surrent $\delta = 0.5$	Per diode	T _c = 160 °C	3	A	
I _{F(AV)} Avera	Average forward current, $\delta = 0.5$	Per device	T _c = 160 °C	6		
I _{FSM}	Surge non repetitive forward current	120	А			
P _{ARM}	Repetitive peak avalanche power $t_p = 10 \ \mu s, T_j = 125 \ ^{\circ}C$			170	W	
T _{stg}	Storage temperature range			-65 to +175	°C	
Тj	Operating junction temperature range ⁽¹⁾			-40 to +175	°C	

1. $(dP_{tot'}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal resistance parameters

Symbol	Parameter	Тур.	Unit
R _{th(j-c)}	Junction to case total	1.5	°C/W

For more information, please refer to the following application note:

AN5088: Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics (per diode)
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Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
L (1)		T _j = 25 °C	V _R = V _{RRM}	-		19	μA
I _R ⁽¹⁾	Reverse leakage current	T _j = 125 °C		-	3	10	mA
		T _j = 25 °C	I _F = 3 A	-	0.56	0.61	V
		T _j = 125 °C		-	0.50	0.57	
V _F ⁽²⁾	Forward valtage drap	T _j = 25 °C	I _F = 4 A	-	0.60	0.65	
v _F Forward	Forward voltage drop	T _j = 125 °C		-	0.53	0.60	
		T _j = 25 °C	I _F = 6 A		0.74		
		T _j = 125 °C	IF - O X	-	0.58	0.66	

1. Pulse test: $t_p = 5 ms$, $\delta < 2\%$

2. Pulse test: t_p = 380 μ s, δ < 2%

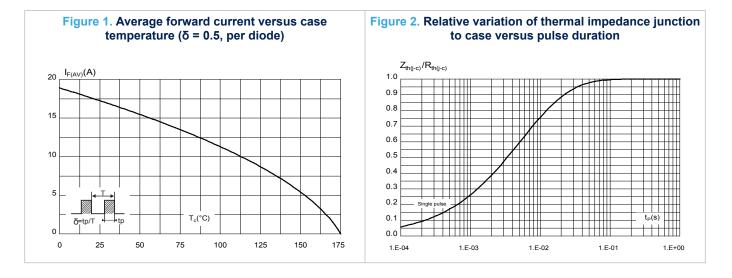
To evaluate the conduction losses, use the following equation:

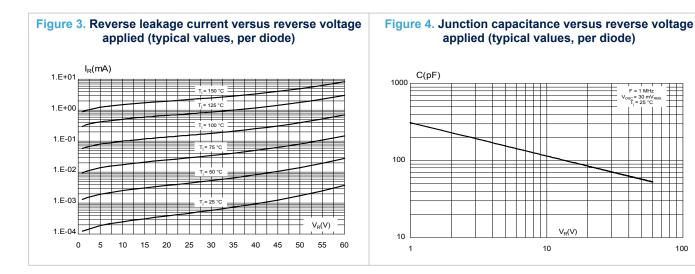
 $P = 0.37 \text{ x } I_{F(AV)} + 0.067 \text{ x } I_{F}^{2}(RMS)$

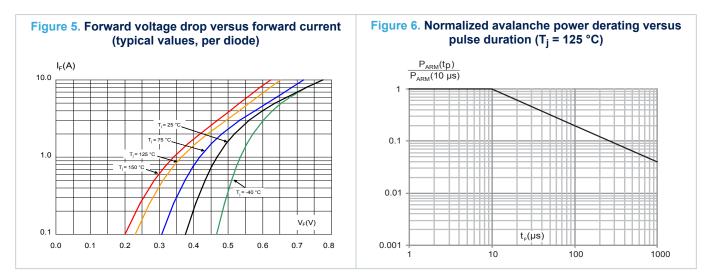
For more information, please refer to the following application notes related to the power losses:

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses in a power diode

1.1 **Characteristics (curves)**







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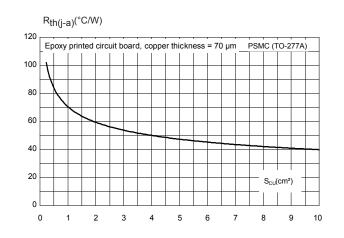


Figure 7. Thermal resistance junction to ambient versus copper surface under tab (typical values, epoxy printed board FR4, e_{Cu} = 70 µm) (PSMC (TO-277A))

2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 PSMC (TO-277A) package information

- Epoxy meets UL94,V0
- Cooling method : by conduction (C)

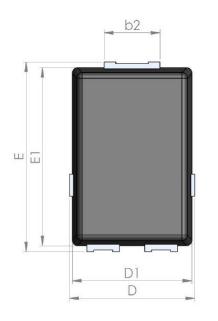
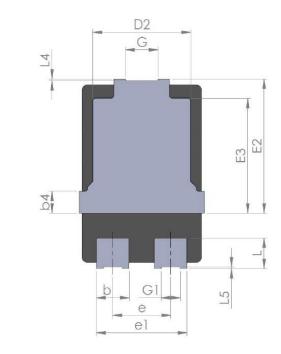


Figure 8. PSMC (TO-277A) package outline

С

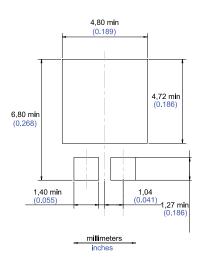




	Dimensions					
Ref.	Millimeters			Inches (for reference only)		
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	1.00	1.10	1.20	0.039	0.043	0.047
b	1.05	1.20	1.35	0.041	0.047	0.053
b2	1.90	2.05	2.20	0.075	0.081	0.087
b4		0.75			0.029	
С	0.15	0.23	0.40	0.006	0.009	0.016
D	4.45	4.60	4.75	0.175	0.181	0.187
D1	4.25	4.40	4.45	0.167	0.173	0.175
D2	3.40	3.60	3.70	0.134	0.142	0.146
E	6.35	6.50	6.65	0.250	0.256	0.262
E1	6.05	6.10	6.15	0.238	0.240	0.242
E2	4.50	4.60	4.70	0.177	0.181	0.185
E3		3.94			1.55	
е		2.13			0.084	
e1		3.33			0.131	
G		1.20			0.047	
G1		0.70			0.027	
L	0.90	1.05	1.24	0.035	0.041	0.049
L4	0.02			0.0008		
L5	0.02			0.0008		

Table 4. PSMC (TO-277A) package mechanical data

Figure 9. PSMC (TO-277A) package footprint in mm (in inches)



Note: For package and tape orientation, reel and inner box dimensions and tape outline please check TN1173



3 Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS660CSFY	PS660CY	PSMC (TO-277A)	90 mg	6000	Tape and Reel

Revision history

Table 6. Document revision history

Date	Version	Changes
26-Oct-2020	1	Initial release.



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